

Lam Research Corporation Announces Participation at Upcoming Conferences

FREMONT, CA -- (Marketwired) -- 05/15/13 -- Lam Research Corporation (NASDAQ: LRCX) today announced its upcoming investor conference schedule:

- May 29, 2013 - Cowen and Company 41st Annual Technology, Media & Telecom Conference, 9:15 a.m. Pacific Time
- June 5, 2013 - Bank of America Merrill Lynch Global Technology Conference, 2:30 p.m. Pacific Time

A live webcast of each presentation will be available to the public and can be accessed from the Investors' section of Lam's website at www.lamresearch.com. Replays of the webcasts will be available for two weeks after the presentation date.

Lam Research Corp. is a major supplier of innovative wafer fabrication equipment and services to the worldwide semiconductor industry. For more than 30 years, the Company has driven continuous improvements in chip performance, power consumption, and cost, contributing to the global proliferation of smartphones, computers, tablets, and other electronic products. Lam Research has been the leading supplier of high-throughput plasma etch equipment for more than a decade and expanded its product offerings in 2008 to include single-wafer clean systems. The Company added thin-film deposition and wafer surface preparation technologies to its product portfolio in 2012 with the acquisition of Novellus Systems, Inc. Headquartered in Fremont, Calif., Lam Research maintains a global network of service facilities throughout North America, Asia, and Europe to rapidly meet the needs of its global customer base. It is an S&P 500® company whose common stock trades on the NASDAQ Global Select Market(SM) under the symbol LRCX. For more information, please visit <http://www.lamresearch.com>.

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Source: Lam Research Corporation

News Provided by Acquire Media

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